

Amendments to the Claims:

The listing of claims will replace all prior versions and listings of claims in the application:

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Listing of Claims:

Claim 1 (currently amended): A liquid crystal display module comprising:

10 a glass substrate having a display area and a peripheral area, a plurality of scan lines and a plurality of data lines is separately formed on the display area along horizontal and vertical directions;

15 at least a gate driver chip mounted directly on the peripheral area of the glass substrate with an anisotropic conductive film or a non-conductive film, the gate driver chip transmits signals to the scan lines via a plurality of output terminals, ~~and~~ thickness of the gate driver chip is less than 0.3 mm, and the gate driver chip is thinned to reduce the stress created between the gate driver chip and the glass substrate; and

20 at least a source driver chip mounted directly on the peripheral area of the glass substrate with the anisotropic conductive film or the non-conductive film, the source driver chip transmits signals to the data lines via a plurality of output terminals, and thickness of the source driver chip is less than 0.3 mm, and the source driver chip is thinned to reduce the stress created between the source driver chip and the glass substrate.

25 Claim 2 (canceled)

Claim 3 (canceled)

Claim 4 (canceled)

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Claim 5 (original): The liquid crystal display module of claim 1 further comprising at least a flexible printed circuit board mounted on the peripheral area.

Claims 6-12 (canceled)

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Claim 13 (currently amended): A liquid crystal display module comprising:

a glass substrate having a display area and a peripheral area, and a plurality of wires formed on the display area along horizontal and vertical directions; and

10 at least a driver chip mounted directly on the peripheral area of the glass substrate with an anisotropic conductive film or a non-conductive film, wherein the thickness of the driver chip is less than 0.3 mm and the driver chip is thinned to reduce the stress created between the chip and the glass substrate.

Claim 14 (canceled)

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Claim 15 (canceled)

Claim 16 (previously presented): The liquid crystal display module of claim 13 further comprising at least a flexible printed circuit board mounted on the peripheral area.

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Claim 17 (previously presented): The liquid crystal display module of claim 13, wherein the wires comprise scan lines and data lines.

Claim 18 (previously presented): The liquid crystal display module of claim 17, wherein the driver chip is a gate driver chip, such that the gate driver chip transmits signals to the scan lines via a plurality of output terminals.

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Claim 19 (previously presented): The liquid crystal display module of claim 17, wherein the driver chip is a source driver chip, such that the source driver chip transmits signals to the data lines via a plurality of output terminals.

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Claim 20 (previously presented): The liquid crystal display module of claim 1, wherein the gate driver chip is bendable.

- 5 Claim 21 (previously presented): The liquid crystal display module of claim 1, wherein the source driver chip is bendable.